117th CONGRESS 1st Session



To amend the Internal Revenue Code of 1986 to establish the semiconductor manufacturing investment credit.

IN THE SENATE OF THE UNITED STATES

Mr. WYDEN (for himself, Mr. CRAPO, Mr. WARNER, Mr. CORNYN, Ms. STABE-NOW, and Mr. DAINES) introduced the following bill; which was read twice and referred to the Committee on ______

A BILL

To amend the Internal Revenue Code of 1986 to establish the semiconductor manufacturing investment credit.

1 Be it enacted by the Senate and House of Representa-

2 tives of the United States of America in Congress assembled,

3 SECTION 1. SHORT TITLE.

4 This Act may be cited as the "Facilitating American-

5 Built Semiconductors Act" or the "FABS Act".

6 SEC. 2. SEMICONDUCTOR MANUFACTURING INVESTMENT
7 CREDIT.

8 (a) IN GENERAL.—Subpart E of part IV of sub-9 chapter A of chapter 1 of the Internal Revenue Code of

1 1986 is amended by inserting after section 48C the fol 2 lowing new section:

3 "SEC. 48D. SEMICONDUCTOR MANUFACTURING INVEST-4 MENT CREDIT.

5 "(a) IN GENERAL.—For purposes of section 46, the
6 semiconductor manufacturing investment credit for any
7 taxable year is an amount equal to the sum of—

8 "(1) 25 percent of the qualified investment for
9 such taxable year with respect to any semiconductor
10 manufacturing facility, and

"(2) 25 percent of the qualified investment for
such taxable year with respect to any semiconductor
manufacturing property.

14 "(b) QUALIFIED INVESTMENT WITH RESPECT TO15 SEMICONDUCTOR MANUFACTURING FACILITIES.—

"(1) IN GENERAL.—For purposes of subsection
(a)(1), the qualified investment with respect to any
semiconductor manufacturing facility for any taxable
year is the basis of any qualified property placed in
service by the taxpayer during such taxable year
which is part of a semiconductor manufacturing facility.

23 "(2) QUALIFIED PROPERTY.—For purposes of
24 this subsection, the term 'qualified property' means
25 property—

1	"(A) which is tangible property (including
2	a building or its structural components) which
3	is an integral part of a semiconductor manufac-
4	turing facility,
5	"(B) with respect to which depreciation (or
6	amortization in lieu of depreciation) is allow-
7	able,
8	"(C) which is—
9	"(i) constructed, reconstructed, or
10	erected by the taxpayer, or
11	"(ii) acquired by the taxpayer if the
12	original use of such property commences
13	with the taxpayer, and
14	"(D) which is necessary for the manufac-
15	turing or processing of, or performing research
16	with respect to, semiconductors or semicon-
17	ductor tooling equipment.
18	"(3) Semiconductor manufacturing facil-
19	ITY.—For purposes of this subpart, the term 'semi-
20	conductor manufacturing facility' means a facility
21	for which the primary purpose is the manufacturing
22	or processing of, or performing research with respect
23	to, semiconductors or semiconductor tooling equip-
24	ment.

1	"(4) COORDINATION WITH REHABILITATION
2	CREDIT AND SEMICONDUCTOR MANUFACTURING
3	PROPERTY.—The qualified investment with respect
4	to any semiconductor manufacturing facility for any
5	taxable year shall not include that portion of the
6	basis of any property which is—
7	"(A) attributable to qualified rehabilitation
8	expenditures (as defined in section $47(c)(2)$), or
9	"(B) semiconductor manufacturing prop-
10	erty (as defined in subsection $(c)(2)$).
11	"(c) Qualified Investment With Respect to
12	Semiconductor Manufacturing Property.—
13	"(1) IN GENERAL.—For purposes of subsection
14	(a)(2), the qualified investment with respect to semi-
15	conductor manufacturing property for any taxable
16	year is the basis of any semiconductor manufac-
17	turing property placed in service by the taxpayer
18	during such taxable year.
19	"(2) Semiconductor manufacturing prop-
20	ERTY.—For purposes of this subpart, the term
21	'semiconductor manufacturing property' means tan-
22	gible property—
23	"(A) for which the primary purpose is to
24	manufacture or process, or perform research

1	with respect to, semiconductors or semicon-
2	ductor tooling equipment,
3	"(B) with respect to which depreciation (or
4	amortization in lieu of depreciation) is allow-
5	able, and
6	"(C) which is—
7	"(i) constructed, reconstructed, or
8	erected by the taxpayer, or
9	"(ii) acquired by the taxpayer if the
10	original use of such property commences
11	with the taxpayer.
12	"(d) Certain Progress Expenditure Rules
13	MADE APPLICABLE.—Rules similar to the rules of sub-
14	sections $(c)(4)$ and (d) of section 46 (as in effect on the
15	day before the date of the enactment of the Revenue Rec-
16	onciliation Act of 1990) shall apply for purposes of sub-
17	section (a).
18	"(e) Regulations and Guidance.—The Secretary
19	shall prescribe such regulations or other guidance as may
20	be necessary or appropriate to carry out the purposes of
21	this section, including regulations or other guidance with
22	respect to—
23	"(1) determining the basis of qualified property
24	and semiconductor manufacturing property,

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1 "(2) any such measures as are deemed appro-2 priate to avoid abuse or fraud with respect to the 3 credit allowed under this section, and "(3) ensuring that such credit is not allowed to 4 5 multiple taxpayers.". 6 (b) ELECTION FOR DIRECT PAYMENT.—Section 48D 7 of the Internal Revenue Code of 1986, as added by sub-8 section (a), is amended by adding at the end the following: 9 "(f) ELECTION FOR DIRECT PAYMENT.— 10 "(1) IN GENERAL.—In the case of any qualified 11 property or semiconductor manufacturing property 12 placed in service during any taxable year (with the 13 exception of any such property to which subsection 14 (d) applied)), the amount of any credit determined 15 under subsection (a) with respect to such property 16 for such taxable year shall, at the election of the tax-17 payer, be treated as a payment equal to such 18 amount which is made by the taxpayer against the 19 tax imposed by chapter 1 for such taxable year (re-20 gardless of whether such tax would have been on 21 such taxpayer). 22 "(2) FORM AND EFFECT OF ELECTION.—An 23 election under paragraph (1) shall be made prior to

25 ductor manufacturing property is placed in service

the date on which the qualified property or semicon-

1	and in such manner as the Secretary may prescribe.
2	Such election, once made, shall—
3	"(A) be irrevocable with respect to the
4	qualified property or semiconductor manufac-
5	turing property to which such election applies,
6	and
7	"(B) reduce the amount of the credit
8	which would (but for this subsection) be allow-
9	able under this section with respect to such
10	property for the taxable year in which such
11	property is placed in service to zero.
12	"(3) Application to partnerships and s
13	corporations.—In the case of a partnership or S
14	corporation which makes an election under para-
15	graph (1) —
16	"(A) such paragraph shall apply with re-
17	spect to such partnership or corporation with-
18	out regard to the fact that no tax is imposed
19	by chapter 1 on such partnership or corpora-
20	tion, and
21	"(B)(i) in the case of a partnership, each
22	partner's distributive share of the credit deter-
23	mined under subsection (a) with respect to the
24	qualified property or semiconductor manufac-
25	turing property shall be deemed to be zero, and

1	"(ii) in the case of a S corporation, each
2	shareholder's pro rata share of the credit deter-
3	mined under subsection (a) with respect to such
4	property shall be deemed to be zero.".
5	(c) Conforming Amendments.—
6	(1) Section 46 of the Internal Revenue Code of
7	1986 is amended—
8	(A) by striking "and" at the end of para-
9	graph (5) ,
10	(B) by striking the period at the end of
11	paragraph (6) and inserting ", and", and
12	(C) by adding at the end the following new
13	paragraph:
14	((7) the semiconductor manufacturing invest-
15	ment credit.".
16	(2) Section $49(a)(1)(C)$ of such Code is amend-
17	ed—
18	(A) by striking "and" at the end of clause
19	(iv),
20	(B) by striking the period at the end of
21	clause (v) and inserting a comma, and
22	(C) by adding at the end the following new
23	clauses:
24	"(vi) the basis of any qualified prop-
25	erty (as defined in section $48D(b)(2)$)

	0
1	which is part of a semiconductor manufac-
2	turing facility, and
3	"(vii) the basis of any semiconductor
4	manufacturing property.".
5	(3) Section $50(a)(2)(E)$ of such Code is amend-
6	ed by striking "or $48C(b)(2)$ " and inserting
7	"48C(b)(2), or 48D(d)".
8	(4) Section $59A(b)(1)(B)(ii)$ of such Code is
9	amended—
10	(A) in subclause (I), by striking "plus",
11	(B) by redesignating subclause (II) as sub-
12	clause (III), and
13	(C) by inserting after subclause (I) the fol-
14	lowing:
15	"(II) the credit allowed under
16	section 38 for the taxable year which
17	is properly allocable to the portion of
18	the investment credit determined
19	under section 46 that is properly allo-
20	cable to section 48D(a), plus".
21	(5) The table of sections for subpart E of part
22	IV of subchapter A of chapter 1 of such Code is
23	amended by inserting after the item relating to sec-
24	tion 48C the following new item:
	"48D. Semiconductor manufacturing investment credit.".
25	(d) Effective Date.—

1 (1) IN GENERAL.—Except as provided under 2 paragraph (2), the amendments made by this section 3 shall apply to property placed in service after De-4 cember 31, 2021, under rules similar to the rules of 5 section 48(m) of the Internal Revenue Code of 1986 6 (as in effect on the day before the date of the enact-7 ment of the Revenue Reconciliation Act of 1990). 8 (2) ELECTION FOR DIRECT PAYMENT.—The 9 amendments made by subsection (b) shall be effective with respect to any election made after Decem-10 11 ber 31, 2021.